UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, Virginia 22313-1450 www.uspto.gov

| APPLICATION NO. | FILING DATE | FIRST NAMED INVENTOR | ATTORNEY DOCKET NO. | CONFIRMATION NO. | |
|-----------------|------------------------------------|----------------------|---------------------|------------------|--|
| 10/671,565 | 09/29/2003 | Yoichi Kodama | 1034232-000025 | 4272 | |
| | 7590 07/14/200 INGERSOLL & ROOI | EXAMINER | | | |
| POST OFFICE | BOX 1404 | HAIDER, SAIRA BANO | | | |
| ALEXANDRIA | A, VA 22313-1404 | ART UNIT | PAPER NUMBER | | |
| | | 1796 | | | |
| | | | | | |
| | | NOTIFICATION DATE | DELIVERY MODE | | |
| | | | 07/14/2008 | ELECTRONIC | |

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

Notice of the Office communication was sent electronically on above-indicated "Notification Date" to the following e-mail address(es):

ADIPFDD@bipc.com

| Office Action Communication | | Application No. Applicant(s) | | | | | | | |
|---|---|--|---|--|---|--------------|--|--|--|
| | | 10/671,565 | | KODAMA ET AL. | | | | | |
| Office Action Summary | | | Examiner | | Art Unit | | | | |
| | | | SAIRA HAII | DER | 1796 | | | | |
| Period fo | The MAILING DATE of this commur or Reply | nication appe | ears on the | cover sheet with the c | correspondence ac | idress | | | |
| WHIC - Exter after - If NC - Failu Any r | ORTENED STATUTORY PERIOD F CHEVER IS LONGER, FROM THE IN Insions of time may be available under the provisions SIX (6) MONTHS from the mailing date of this coming period for reply is specified above, the maximum single to reply within the set or extended period for reply eply received by the Office later than three months and patent term adjustment. See 37 CFR 1.704(b). | MAILING DA s of 37 CFR 1.136 munication. tatutory period will will, by statute, co | TE OF THIS 6(a). In no even Il apply and will cause the applic | S COMMUNICATION t, however, may a reply be tin expire SIX (6) MONTHS from ation to become ABANDONE | N. nely filed the mailing date of this o D (35 U.S.C. § 133). | | | | |
| Status | | | | | | | | | |
| 1)[\ | Responsive to communication(s) file | ed on 28 Ani | ril 2008 | | | | | | |
| • | Responsive to communication(s) filed on <u>28 April 2008</u> . This action is FINAL . 2b) This action is non-final. | | | | | | | | |
| 3) | | <i>'</i> — | | | secution as to the | e merits is | | | |
| ٥/١ | Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213. | | | | | | | | |
| Dispositi | on of Claims | | , | ,, | | | | | |
| - | | in the applie | ation | | | | | | |
| ·— | Claim(s) <u>1,3,4 and 7</u> is/are pending in the application. 4a) Of the above claim(s) is/are withdrawn from consideration. | | | | | | | | |
| | | are williurawi | II IIOIII COIR | sideration. | | | | | |
| | 5) Claim(s) is/are allowed. | | | | | | | | |
| · | S)⊠ Claim(s) <u>1,3,4 and 7</u> is/are rejected. | | | | | | | | |
| • | Claim(s) is/are objected to. | | | . , | | | | | |
| 8)[_] | 8) Claim(s) are subject to restriction and/or election requirement. | | | | | | | | |
| Applicati | on Papers | | | | | | | | |
| 9) | The specification is objected to by th | ne Examiner. | | | | | | | |
| 10) | The drawing(s) filed on is/are | : a) <u>□</u> acce _l | pted or b)[| objected to by the I | Examiner. | | | | |
| | Applicant may not request that any obje | ction to the di | rawing(s) be | held in abeyance. See | e 37 CFR 1.85(a). | | | | |
| | Replacement drawing sheet(s) including | g the correctio | on is required | d if the drawing(s) is ob | jected to. See 37 C | FR 1.121(d). | | | |
| 11) | 11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152. | | | | | | | | |
| Priority ι | ınder 35 U.S.C. § 119 | | | | | | | | |
| 12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) All b) Some * c) None of: 1. Certified copies of the priority documents have been received. 2. Certified copies of the priority documents have been received in Application No 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. | | | | | | | | | |
| 2) Notic 3) Inform | t(s) e of References Cited (PTO-892) e of Draftsperson's Patent Drawing Review (Fination Disclosure Statement(s) (PTO/SB/08) r No(s)/Mail Date | PTO-948) | | 4) Interview Summary Paper No(s)/Mail Da 5) Notice of Informal F 6) Other: | ate | | | | |

Art Unit: 1796

DETAILED ACTION

Page 2

Continued Examination Under 37 CFR 1.114

1. A request for continued examination under 37 CFR 1.114, including the fee set forth in 37 CFR 1.17(e), was filed in this application after final rejection. Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, the finality of the previous Office action has been withdrawn pursuant to 37 CFR 1.114. Applicant's submission filed on 4/28/2008 has been entered.

Claim Rejections - 35 USC § 112

- 2. The following is a quotation of the first paragraph of 35 U.S.C. 112:
 - The specification shall contain a written description of the invention, and of the manner and process of making and using it, in such full, clear, concise, and exact terms as to enable any person skilled in the art to which it pertains, or with which it is most nearly connected, to make and use the same and shall set forth the best mode contemplated by the inventor of carrying out his invention.
- 3. Claims 1, 3, 4, and 7 are rejected under 35 U.S.C. 112, first paragraph, as failing to comply with the written description requirement. The claim(s) contains subject matter which was not described in the specification in such a way as to reasonably convey to one skilled in the relevant art that the inventor(s), at the time the application was filed, had possession of the claimed invention. The newly added limitation to claim 1 which specifies that the metal laminate has a solder heat resistance of not less than 300°C is not supported by applicant's specification. It is noted that applicant's specification states that the instant invention improves the solder heat resistance by about 20°C or more from those of conventional techniques, wherein applicant identifies conventional techniques as having a solder heat resistance of 260°C or less (page 25). From this disclose it cannot be definitely determined that the claimed metal laminate has a solder heat resistance of not less than 300°C. It is noted that in Table 2 of applicant's specification, certain points (300°C, 320°C, 350°C, and 360°C) in the claimed range are supported for specific embodiments, however, the entire

Art Unit: 1796

claimed range is not supported (values greater than 360°C). Accordingly, the disclosure and examples provided by applicant are insufficient to support the entire claimed range.

Claim Rejections - 35 USC § 103

Page 3

- 4. The text of those sections of Title 35, U.S. Code not included in this action can be found in a prior Office action.
- 5. Claims 1, 3, 4 and 7 are rejected under 35 U.S.C. 103(a) as being unpatentable over Yamaya et al. in view of Matsuura et al. (US 5,508,357), and in further view of Arai et al. (US 6,054,509).
- 6. Yamaya discloses thermosetting resin compositions comprising a polyimide and a bismaleimide, wherein the resins exhibit excellent heat resistance properties. Specifically, Yamaya discloses the claimed bismaleimide with the meta-position substitution (Formula (III)) and the claimed polyimide (Formula (I) (col.2, lines 44-69; col. 4, lines 60-61, Table 1 (Examples 9-17)).
- 7. Yamaya fails to disclose that the thermosetting resin composition is present in a laminate composite comprising a metal foil layer and a polyimide layer, as claimed. However, Yamaya discloses that the thermosetting resin compositions are excellent in adhesion, formability, moldability, flexibility and heat resistance. Further, the resin compositions have numerous applications including as adhesives, laminates and molding materials in electrical and electronic equipment and apparatus (col. 6, lines 14-20). Attention is directed towards the Matsuura reference.
- 8. Matsuura teaches similar polyimide/bismaleimide thermosetting compositions, where the materials are applied to metal foils and as adhesives between polyimide films and metal foils (col. 11 lines 51-62; col. 12 lines 34-63). The articles are formed to provide substrates for flexible printed circuit boards or TAB tapes. It is the examiner's position that it would have been prima facie obvious to use the polyimide/bismaleimide compositions of Yamaya's invention applied to metal foils or between polyimide films and metal foils to form substrates for flexible printed circuit boards

or TAB tapes having Yamaya's improved toughness, flexibility, adhesion, and heat resistance properties. The position is supported by the fact that the resin of Yamaya is exemplified as capable of bonding to steel sheets (col. 7, line 31 to col. 8, line 2).

- 9. Regarding the limitations drawn to the polyimide, Yamaya teaches polyimides fitting the claimed formulas (1) and (4) (col. 1 line 54-col. 2 line 30; examples).
- 10. In reference to the limitation regarding the metal foils, Matsuura discloses copper foil and aluminum foil as suitable metal foils; however, Matsuura fails to disclose the claimed rolled copper foil or electrolytic copper foil as suitable. Thus attention is directed towards the Arai reference, which discloses that the metal foil of flexible printed circuit boards can be selected from a variety of metal foils including electrolytic copper foils, rolled copper foils, and aluminum foils. Wherein the electrolytic and rolled copper foils are most widely employed as metal foils in respect of their good flexibility and high electric conductivity (col. 4, lines 22-33). Therefore, given that the electrolytic copper foils and rolled copper foils are advantageous over aluminum foils, it would have been obvious to one of ordinary skill in the art at the time of the invention to utilize either electrolytic copper foils or rolled copper foils as the metal foil in the invention taught by the combination of Yamaya and Matsuura.
- 11. In reference to the claim 7, Arai discloses that the thickness of the metal foil is usually 18 to 70 µm (col. 4, lines 22-33). It would have been obvious to use the either electrolytic copper foils and rolled copper foils in the thickness specified by Arai in order to fully embody the invention taught by the combination of Yamaya, Matsuura, and Arai.
- 12. In reference to the limitation regarding the metal laminate is used as a based material for a chip-on-film or flexible substrate, the combination of references teaches this limitation. Specifically, the examiner has stated in the rejection above, that it would have been prima facie obvious to use

Art Unit: 1796

the polyimide/bismaleimide compositions of Yamaya's invention applied to metal foils or between

Page 5

polyimide films and metal foils to form substrates for flexible printed circuit boards or TAB tapes

having Yamaya's improved properties.

13. In reference to the newly added limitation specifying that the metal laminate has a solder

heat resistance of not less than 300°C, it is noted that since the combination of prior art references

teach the identical chemical structures, the properties applicant discloses and/or claims are

necessarily present. In re Spada, 911 F.2d 705, 709, 15 USPQ2d 1655, 1658 (Fed. Cir. 1990). Note,

that because the references do not expressly teach or address the properties of the claimed

invention, it does not mean that the properties are not inherently disclosed. Teaching the same

compound(s) inherently discloses the corresponding properties. The references cannot possibly

teach or address all of the properties, but implicitly all of the properties are present.

14. Once a reference teaching product appearing to be substantially identical is made the basis of

a rejection, and the examiner presents evidence or reasoning tending to show inherency, as done

above, the burden shifts to the applicant to show an unobvious difference. "[T]he PTO can require

an applicant to prove that the prior art products do not necessarily or inherently possess the

characteristics of his [or her] claimed product. Whether the rejection is based on 'inherency' under

35 U.S.C. 102, on 'prima facie obviousness' under 35 U.S.C. 103, jointly or alternatively, the burden of

proof is the same...[footnote omitted]." The burden of proof is similar to that required with respect

to product-by-process claims. In re Fitzgerald, 619 F.2d 67, 70, 205 USPQ 594, 596 (CCPA 1980)

(quoting In re Best, 562 F.2d 1252, 1255, 195 USPQ 430, 433-34 (CCPA 1977)).

Art Unit: 1796

Response to Arguments

Page 6

15. The examiner has thoroughly considered the newly added limitation and has presented a

prima facie case of obviousness.

16. In response to applicant's argument that the cited prior art fails to recognize the results

obtained by the claimed invention, the fact that applicant has recognized another advantage which

would flow naturally from following the suggestion of the prior art cannot be the basis for

patentability when the differences would otherwise be obvious. See Ex parte Obiaya, 227 USPQ 58,

60 (Bd. Pat. App. & Inter. 1985).

17. It is noted that, as per MPEP § 2112, there is no requirement that the person of ordinary

skill in the art would have recognize the inherent disclosure (solder heat resistance value) at the time

of the invention, but only that the subject matter is in fact inherent in the prior art reference. As

noted in the rejection above, since the prior art compounds comprising the metal laminate are

identical to those claimed, the solder heat resistance property claimed is necessarily present in the

compound taught by the prior art.

Any inquiry concerning this communication or earlier communications from the examiner

should be directed to SAIRA HAIDER whose telephone number is (571)272-3553. The examiner

can normally be reached on Monday-Friday from 10am-6pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor,

Randy P. Gulakowski can be reached on (571) 272-1302. The fax phone number for the

organization where this application or proceeding is assigned is 571-273-8300.

Art Unit: 1796

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

/Randy Gulakowski/ Supervisory Patent Examiner, Art Unit 1796 Saira Haider Examiner Art Unit 1796 Page 7